DF005S Thru DF10S

1 AMP SURFACE MOUNT GLASS PASSIVATED SILICON BRIDGE

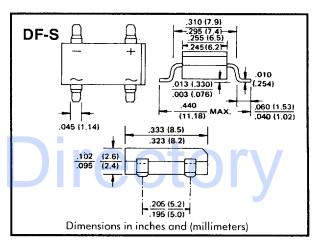
FEATURES

- Rating to 1000V PRV
- Surge overload rating to 45 Amperes peak
- Ideal for printed circuit board
- Reliable low cost construction utilizing molded plastic technique results in inexpensive product
- UL recognized: File #E106441
- UL recognized 94V-O plastic material

Mechanical Data

- Case: Molded plastic
- Leads: Tin plated copper
- Leads solderable per MIL-STD-202, Method 208
- Polarity: Symbols molded on body
- Weight: 0.02 ounce, 0.38 grams

Outline Drawing



Maximum Ratings & Characteristics

- Ratings at 25° C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load, derate current by 20%

		DF005S	DF01S	DF02S	DF04S	DF06S	DF08S	DF10S	Units
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	Vpc	50	100	200	400	600	800	1000	V
Maximum Average Forward @ T _A = 40°C Output Current	l (AV)	1.0							А
Peak Forward Surge Current									
8.3 ms Single Half-Sine-Wave	IFSM 50								Α
Superimposed On Rated Load									
Maximum DC Forward Voltage AT 1.0A DC	VF				1.1				V
Maximum DC Reverse Current @ T _A = 25°C	le.	10 500							μА
At Rated DC Blocking Voltage @ T _A = 125°C	IH.								
I ² t Rating for Fusing (t < 8.3ms)	l² t	10.4							A ² S
Typical Thermal Resistance per Element	CJ				25				pF
Typical Thermal Resistance	RTHJC	40							°C/W
Operating Temperature Range	Tj	-55 to +125							°C
Storage Temperature Range	Tstg	-55 to +150							°C

Collmer Semiconductor, Inc. • (214) 233-1589